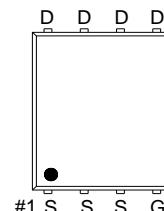
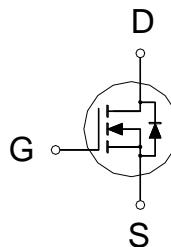


**NIKO-SEM**
**N-Channel Enhancement Mode  
Field Effect Transistor**
**PP2H06BK**  
**PDFN 5x6P**  
**Halogen-Free & Lead-Free**
**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
60V	2.8mΩ	131A


**G. GATE  
D. DRAIN  
S. SOURCE**
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	60	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	$I_D$	131	A
	$T_C = 100^\circ\text{C}$		93	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	166	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	$I_D$	28	
	$T_A = 70^\circ\text{C}$		23	
Avalanche Current		$I_{AS}$	54	
Avalanche Energy	$L = 0.1\text{mH}$	$E_{AS}$	145	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	107	W
	$T_C = 100^\circ\text{C}$		53	
Power Dissipation <sup>3</sup>	$T_A = 25^\circ\text{C}$	$P_D$	5	W
	$T_A = 70^\circ\text{C}$		3.5	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 175	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10\text{s}$	$R_{\theta JA}$	$^{\circ}\text{C} / \text{W}$	30	$^{\circ}\text{C} / \text{W}$
Junction-to-Ambient <sup>2</sup>	Steady-State	$R_{\theta JA}$		65	
Junction-to-Case	Steady-State	$R_{\theta JC}$		1.4	

<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .<sup>3</sup>The Power dissipation is based on  $R_{\theta JA}$   $t \leq 10\text{s}$  value.

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**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1	1.6	2.6	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V			1	μA
		V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C			10	
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		2.2	2.8	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A		3.3	4.4	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 20A		86		S
<b>DYNAMIC</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 30V, f = 1MHz		3355		pF
Output Capacitance	C <sub>oss</sub>			1569		
Reverse Transfer Capacitance	C <sub>rss</sub>			45		
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz		1		Ω
Total Gate Charge <sup>2</sup>	Q <sub>g</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		57		nC
				29		
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>			7.7		
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>			11.5		
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>	V <sub>DS</sub> = 30V , I <sub>D</sub> ≈ 20A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		15		nS
Rise Time <sup>2</sup>	t <sub>r</sub>			19		
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>			47		
Fall Time <sup>2</sup>	t <sub>f</sub>			68		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b>						
Continuous Current	I <sub>S</sub>	I <sub>F</sub> = 20A, V <sub>GS</sub> = 0V			89	A
Forward Voltage <sup>1</sup>	V <sub>SD</sub>				1.2	V
Reverse Recovery Time	t <sub>rr</sub>			88		nS
Reverse Recovery Charge	Q <sub>rr</sub>			80		nC

<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

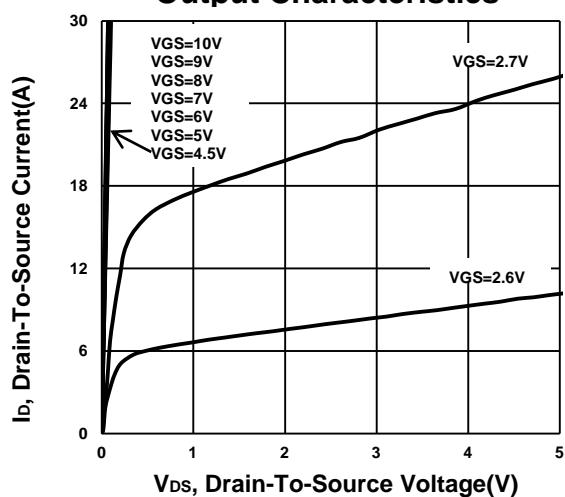
<sup>2</sup>Independent of operating temperature.

**NIKO-SEM**

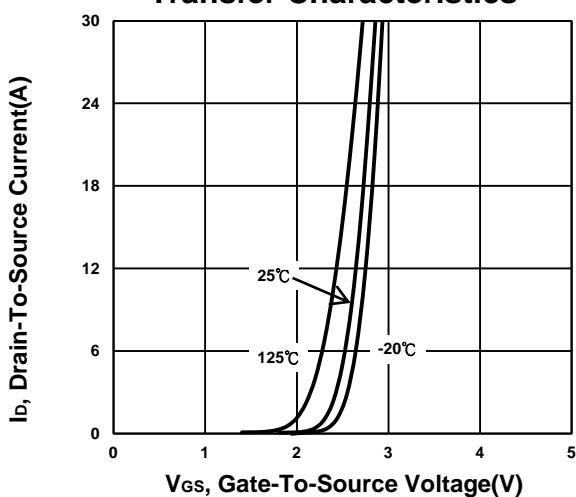
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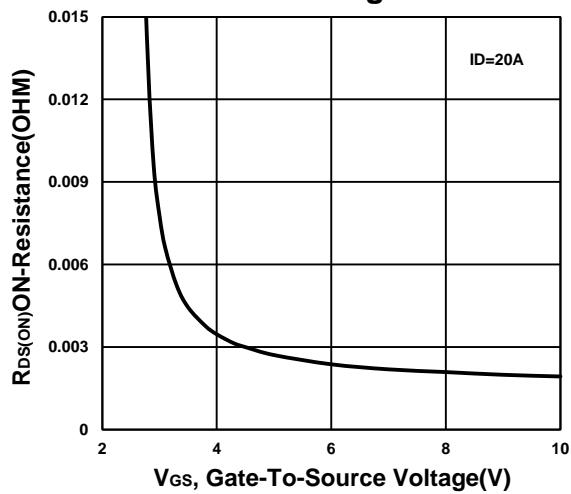
**Output Characteristics**



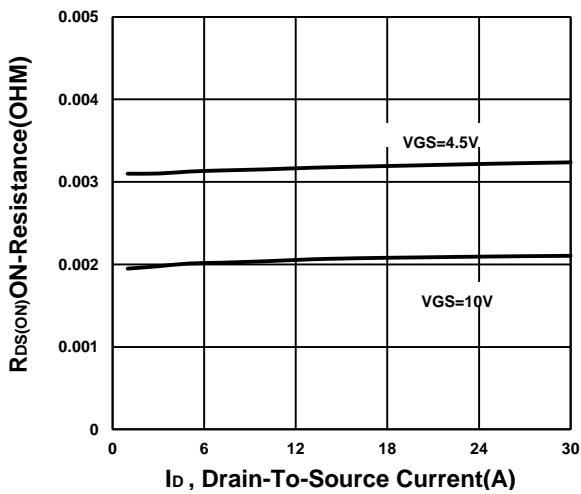
**Transfer Characteristics**



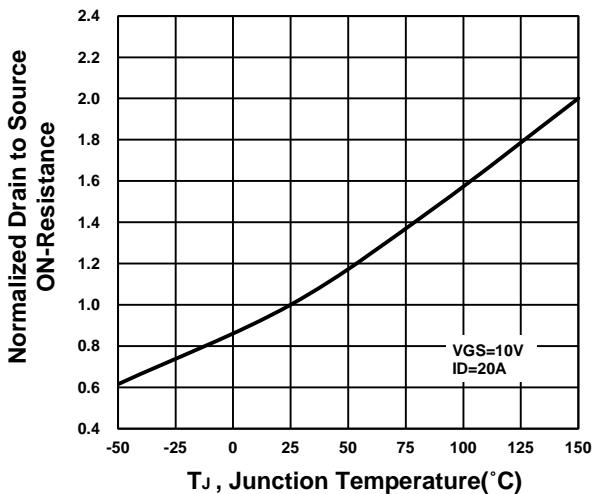
**On-Resistance VS Gate-to-Source Voltage**



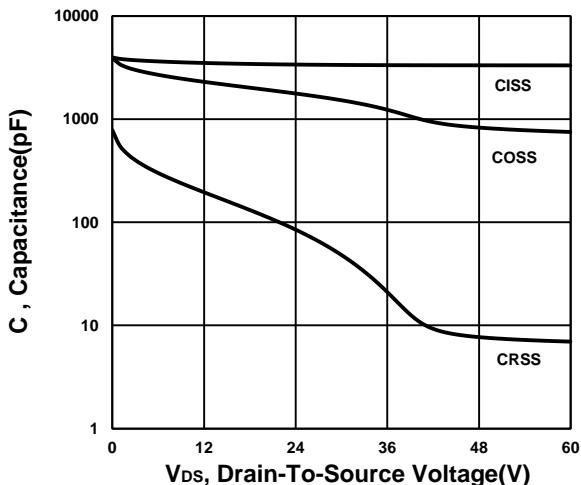
**On-Resistance VS Drain Current**



**On-Resistance VS Temperature**



**Capacitance Characteristic**

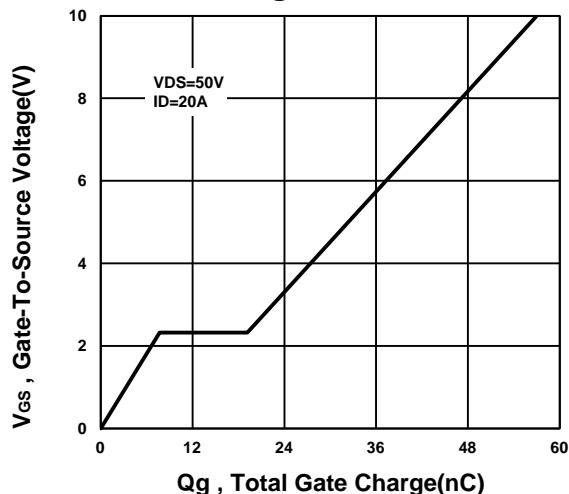


**NIKO-SEM**

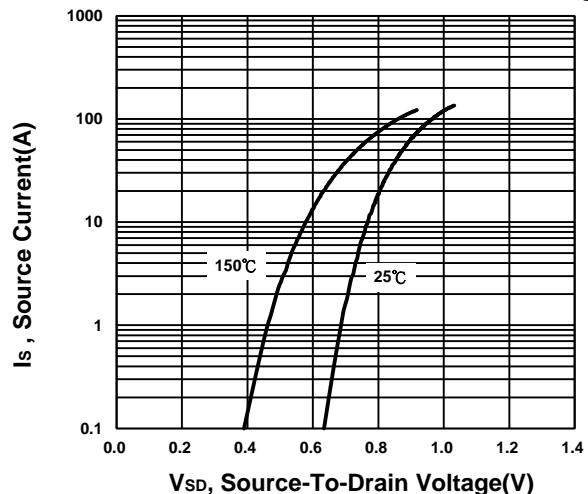
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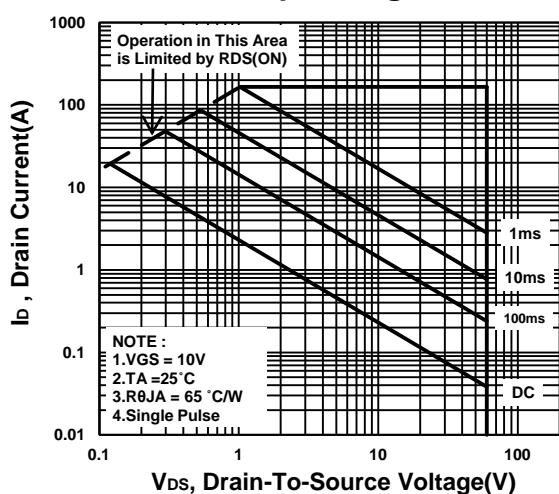
**Gate charge Characteristics**



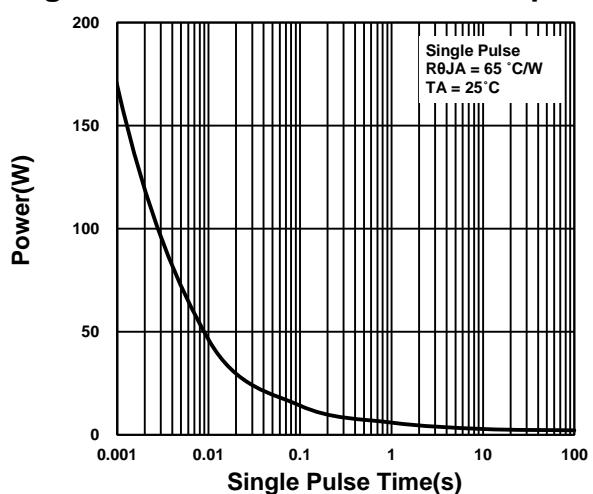
**Source-Drain Diode Forward Voltage**



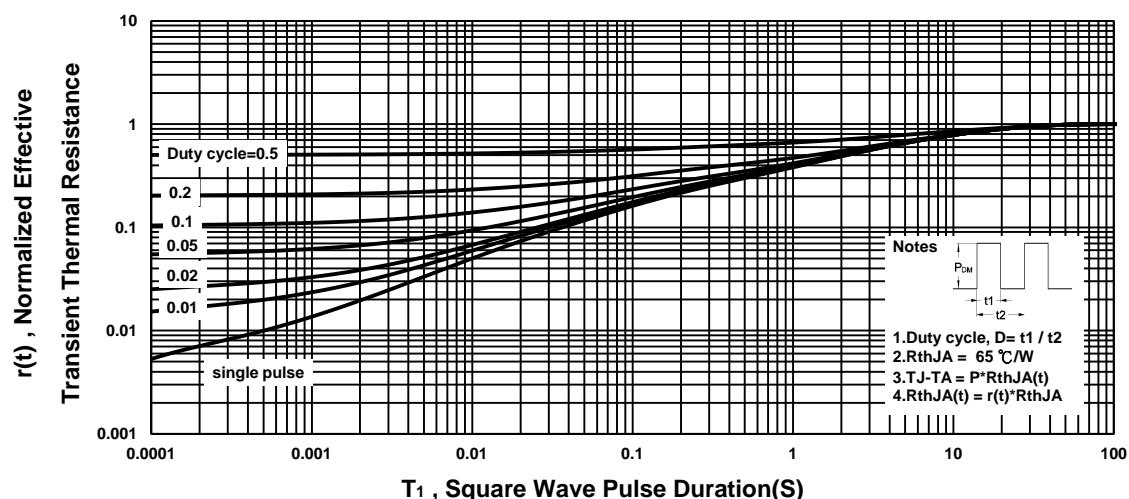
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

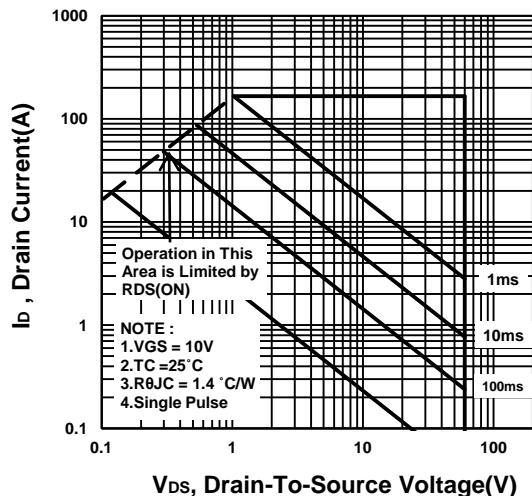


**NIKO-SEM**

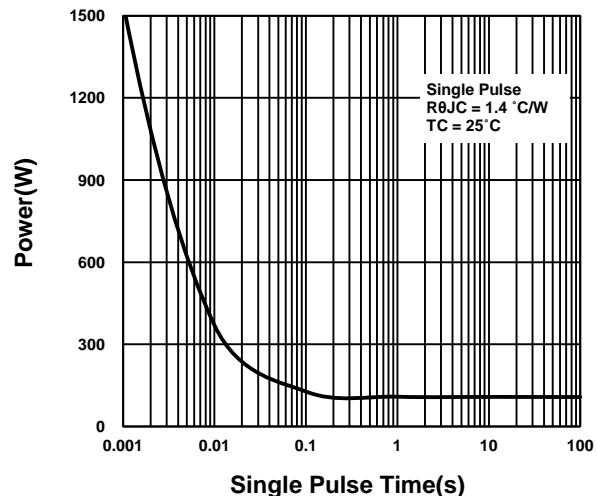
**N-Channel Enhancement Mode  
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**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

